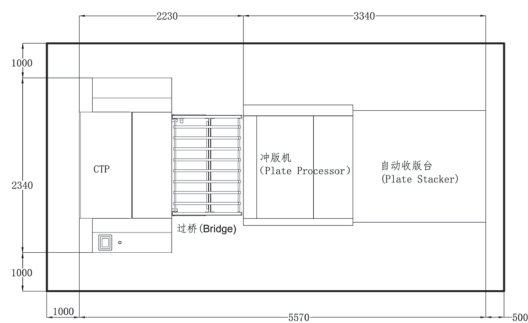
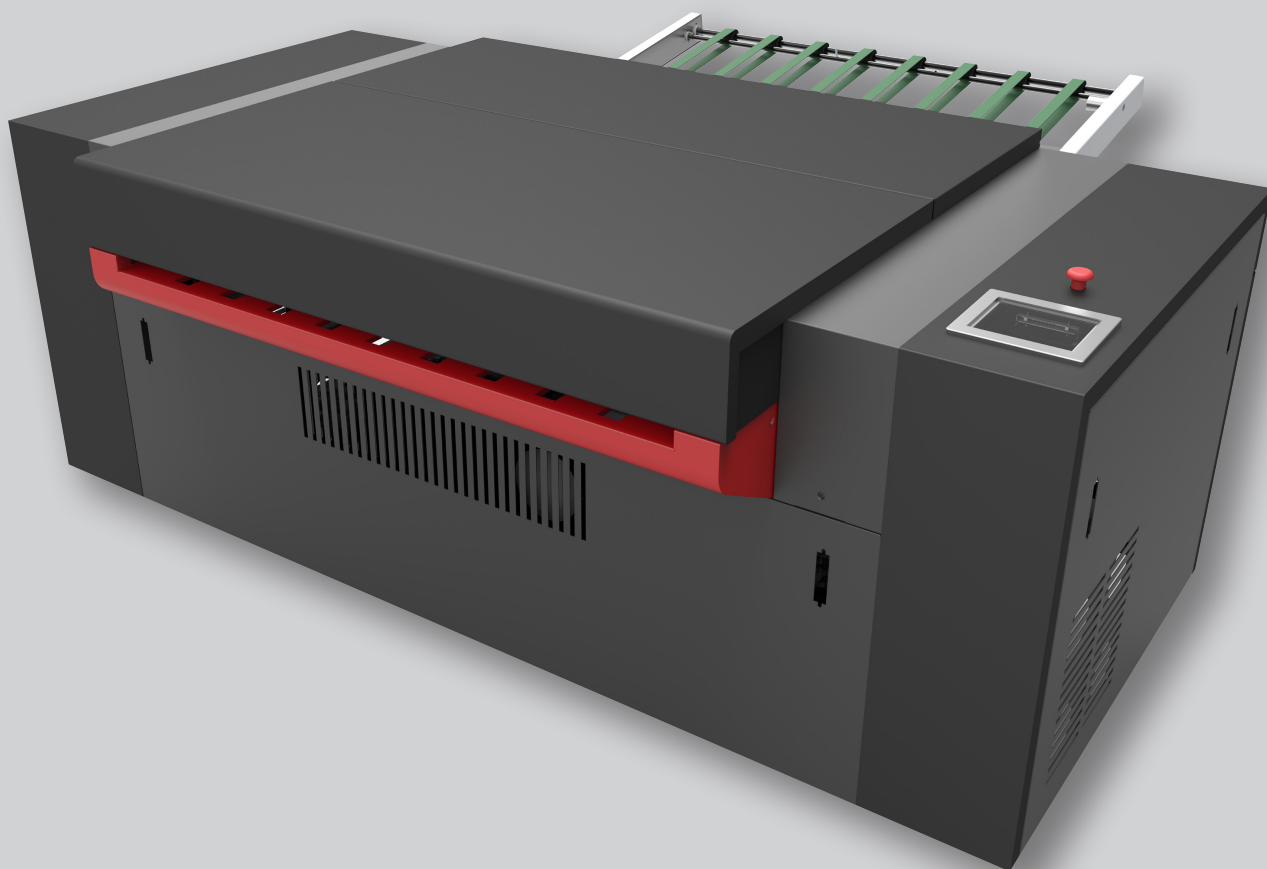


热敏 & UV 东信 1160E (CTP)

Thermal & UV CTP DX1160E



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技术参数

型号	DX1160ET/U-I	DX1160ET/U-II	DX1160ET/U-III	DX1160ET/U-IV
激光路数	32 路 (830/405nm) 半导体激光	48 路 (830/405nm) 半导体激光	64 路 (830/405nm) 半导体激光	96 路 (830/405nm) 半导体激光
输出分辨率	2400dpi/1200dpi (可选)			
输出速度 (2400dpi, 1030mm × 800mm, 连线出版)	15p/h	21p/h	25p/h	31p/h
输出速度 (1200dpi, 575mm × 800mm, 连线出版)	28p/h	36p/h	40p/h	45p/h
制版方式	外鼓式			
版材尺寸	最大尺寸 1130mm × 930mm; 最小尺寸 450 mm × 370mm			
版材类型	热敏 (830nm) 0.15 ~ 0.4mm/ UV (405nm) 0.15 ~ 0.4mm			
最高加网线数	300lpi			
FM 网点输出	10 μ m 混合加网			
重复精度	± 0.005mm			
电源要求	AC 220V/50/60Hz 6kW Peak (Single phase)			
外形尺寸	L × W × H =2400mm × 1375mm × 1090mm 1400kg			

Technical parameters

Model	DX1160ET/U-I	DX1160ET/U-II	DX1160ET/U-III	DX1160ET/U-IV
Laser system	830/405nm LD,32 channels	830/405nm LD,48 channels	830/405nm LD,64 channels	830/405nm LD,96 channels
Resolution	2400dpi/1200dpi (optional)			
Output speed (2400dpi, 1030mm × 800mm, Online plate making)	15p/h	21p/h	25p/h	31p/h
Output speed (1200dpi, 575mm × 800mm, Online plate making)	28p/h	36p/h	40p/h	45p/h
Exposure Structure	External drum			
Plate size	Max. 1130mm × 930mm; Min. 450 mm × 370mm			
Plate thickness	Thermal (830nm) 0.15 ~ 0.4mm / UV (405nm) 0.15 ~ 0.4mm			
Max hanged line	300lpi			
FM dots output	10 μ m AM/FM hybrid screening			
Repeatability	± 0.005mm			
Power supply	AC 220V/50/60Hz 6kW Peak (Single phase)			
External dimension	L × W × H =2400mm × 1375mm × 1090mm 1400kg			

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